









ProLight PM2F-3LLx-SD
3W UV Power LED
Technical Datasheet
Version: 1.1

# **ProLight Opto PM2F Series**

#### **Features**

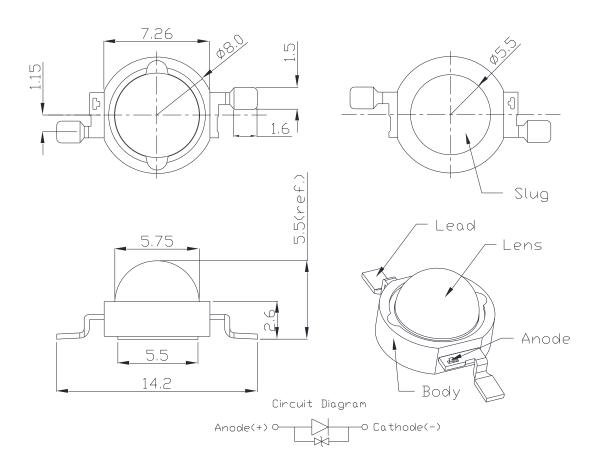
- · Instant light (less than 100ns)
- · Low-temp. & lead free reflow soldering
- · RoHS compliant
- · Cool beam, safe to the touch

#### **Main Applications**

- · UV gluing, UV curing, UV marking
- · UV drying of printing inks and lacquers
- · Currency inspection
- · Forensic analysis urine, protein stains
- · Leak detection using fluorescent dyes
- · Detects fluorescing minerals and gems
- · Indoor Lighting
- · Outdoor Lighting



#### **Emitter Mechanical Dimensions**



#### Notes:

- 1. The Anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. Do not electrically connect either the anode or cathode to the slug.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. Unless otherwise indicated, tolerances are  $\pm$  0.20mm.
- 6. Please do not bend the leads of the LED, otherwise it will damage the LED.
- 7. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

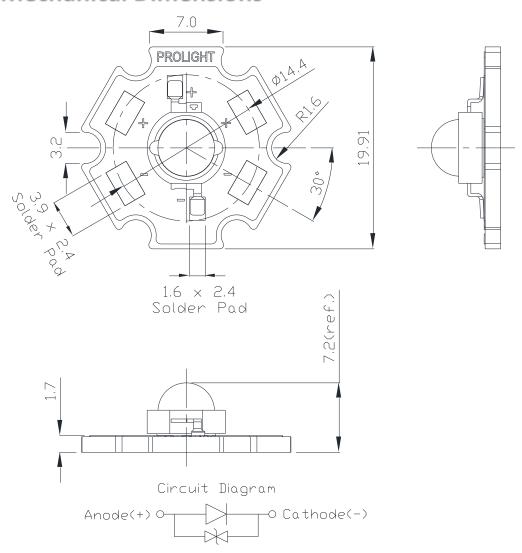
\*The appearance and specifications of the product may be modified for improvement without notice.

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#### **Star Mechanical Dimensions**



#### Notes:

- 1. Slots in aluminum-core PCB for M3 or #4 mounting screw.
- 2. Electrical interconnection pads labeled on the aluminum-core PCB with "+" and "-" to denote positive and negative, respectively. All positive pads are interconnected, as are all negative pads, allowing for flexibility in array interconnection.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. Unless otherwise indicated, tolerances are  $\pm$  0.20mm.
- 6. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

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## Power Characteristics, T<sub>J</sub> = 25°C

Dediction	Part Number			Radiometric Power (mW)		
Radiation Pattern	Color	Emittor	Ctor.	@700	mA	Refer @350mA
Fattern		Emitter	Star	Min.	Тур.	Тур.
Lambertian	UV	PM2F-3LLE-SD	PM2F-3LLS-SD	1050	1300	640

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

### Electrical Characteristics, T<sub>j</sub> = 25°C

		<b>/</b> )	Thermal Resistance		
Color		@700mA		Refer @350mA	Junction to Slug (°C/W)
	Min.	Тур.	Max.	Тур.	
UV	3.10	3.70	4.35	3.30	8

ullet ProLight maintains a tolerance of  $\pm$  0.1V for Voltage measurements.

## Optical Characteristics at 700mA, $T_1 = 25$ °C

					Total included Angle	Viewing Angle
Radiation	Color	Dominant Wavelength $\lambda_{\text{p}}$			(degrees) (degrees)	
Pattern		Min.	Тур.	Max.	θ <sub>0.90V</sub>	2 θ <sub>1/2</sub>
Lambertian	UV	390 nm	400 nm	410 nm	180	130

ullet ProLight maintains a tolerance of  $\pm$  1nm for dominant wavelength measurements.

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### **Absolute Maximum Ratings**

Parameter	UV
DC Forward Current (mA)	700
Peak Pulsed Forward Current (mA)	1000 (less than 1/10 duty cycle@1KHz)
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	> ±500V
LED Junction Temperature	120°C
Operating Board Temperature at Maximum DC Forward Current	-40°C - 100°C
Storage Temperature	-40°C - 120°C
Soldering Temperature	JEDEC 020c 240°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

#### Radiometric Power Bin Structure at 700mA

Color	Bin Code	Minimum Radiometric Power (mW)	Maximum Radiometric Power (mW)	Available Color Bins
UV	V W X	1050 1225 1400	1225 1400 1680	2,3,4 <sup>[1]</sup> [1] [1]

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- [1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

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### **Peak Wavelength Bin Structure**

Color	Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
	1	390	395
UV	2	395	400
ΟV	3	400	405
	4	405	410

<sup>•</sup> ProLight maintains a tolerance of ± 1nm for peak wavelength measurements.

### Forward Voltage Bin Structure at 700mA

Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
	В	3.10	3.35
	D	3.35	3.60
UV	E	3.60	3.85
	F	3.85	4.10
	G	4.10	4.35

 $<sup>\</sup>bullet$  ProLight maintains a tolerance of  $\pm\,0.1V$  for Voltage measurements.

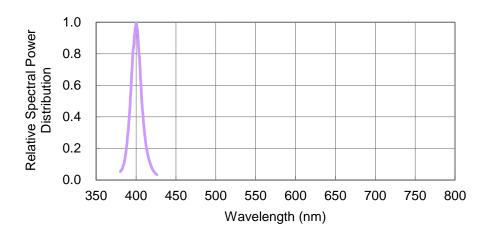
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

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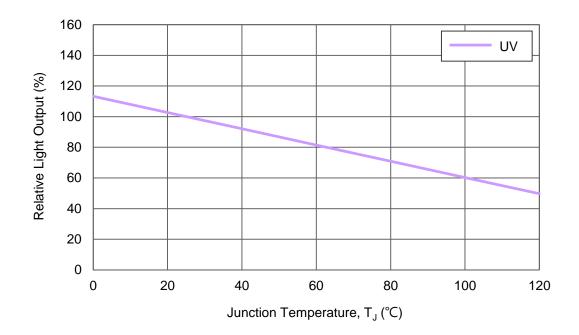
## Color Spectrum, $T_1 = 25^{\circ}C$

1. UV



## **Light Output Characteristics**

Relative Light Output vs. Junction Temperature at 700mA



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### Forward Current Characteristics, T<sub>j</sub> = 25°C

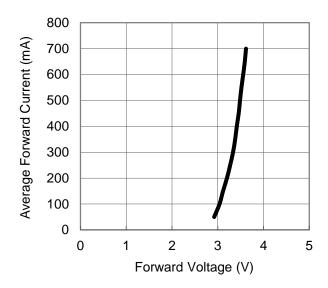


Fig 1. Forward Current vs. Forward Voltage

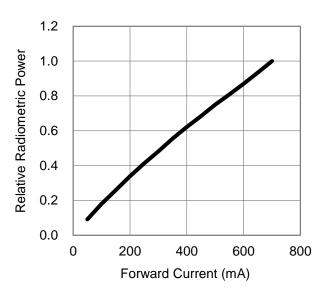
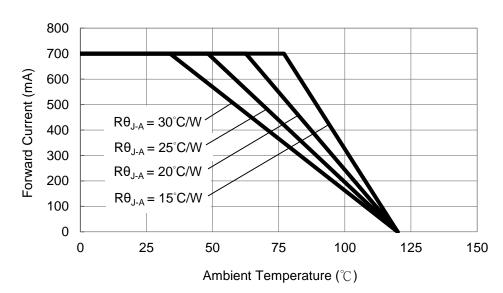


Fig 2. Relative Radiometric Power vs. Forward Current at T<sub>.1</sub>=25°C maintained.

#### **Ambient Temperature vs. Maximum Forward Current**

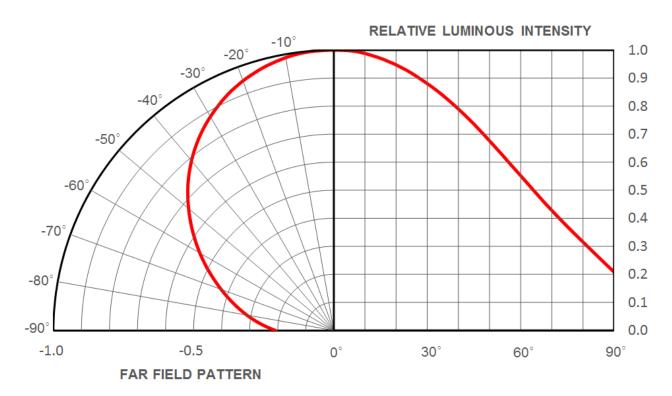
1. UV  $(T_{JMAX} = 120^{\circ}C)$ 



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## **Typical Representative Spatial Radiation Pattern**





## **Qualification Reliability Testing**

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C ± 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

#### Notes:

- 1. Depending on the maximum derating curve.
- 2. Criteria for judging failure

Item	Test Condition	Criteria for	Judgement
item	Test Condition	Min.	Max.
Forward Voltage (V <sub>F</sub> )	$I_F = max DC$	-	Initial Level x 1.1
Luminous Flux or Radiometric Power (Φ <sub>V</sub> )	I <sub>F</sub> = max DC	Initial Level x 0.7	-

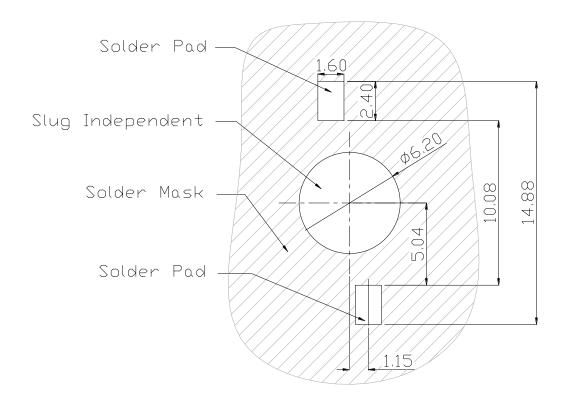
<sup>\*</sup> The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

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## **Recommended Solder Pad Design**



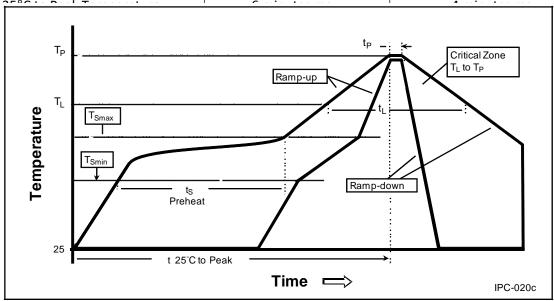
• All dimensions are in millimeters.

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### **Reflow Soldering Condition**

Profile Feature	Sn-Pb Eutectic Assembly	Low-Temp. & Pb-Free Assembly (58Bi-42Sn Eutectic Alloy)
Average Ramp-Up Rate (T <sub>Smax</sub> to T <sub>P</sub> )	3°C / second max.	2°C / second max.
Preheat		
<ul><li>Temperature Min (T<sub>Smin</sub>)</li></ul>	100°C	90°C
– Temperature Max (T <sub>Smax</sub> )	150°C	120°C
– Time (t <sub>smin</sub> to t <sub>smax</sub> )	60-120 seconds	60-120 seconds
Time maintained above:		
– Temperature (T <sub>L</sub> )	183°C	138°C
– Time (t, )	60-150 seconds	20-50 seconds
Peak/Classification Temperature (T <sub>P</sub> )	240°C	185°C
Time Within 5°C of Actual Peak	10.20 seconds	10.20 seconds
Temperature (t <sub>p</sub> )	10-30 seconds	10-30 seconds
Ramp-Down Rate	6°C/second max.	3°C/second max.
Time 25°C - David Talana and a	C	A

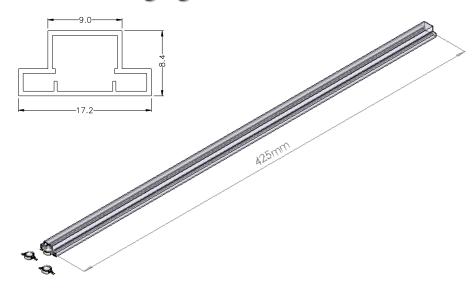


- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
  double-head soldering iron should be used. It should be confirmed beforehand whether the
  characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

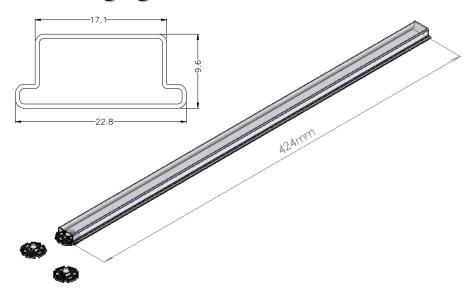
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#### **Emitter Tube Packaging**



#### **Star Tube Packaging**



#### Notes:

- 1. Emitter 50 pieces per tube and Star 20 pieces per tube.
- 2. Drawing not to scale.
- 3. All dimensions are in millimeters.
- 4. All dimendions without tolerances are for reference only.
- \*\*Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH.

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#### **Precaution for Use**

Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.

- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

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